



SUGGESTED PCB LAYOUT
(COMPONENT SIDE)

PCB LAYOUT
TOLERANCE
.XX±0.05[0.002]

1. MATERIALS:
HOUSING: HIGH TEMP. THERMOPLASTIC, BLACK, UL 94V-0
CONTACTS: 0.014 INCHES (0.35 MILLIMETERS) THICK PHOSPHOR BRONZE PLATED WITH 150 MICROINCHES (3.81 MICROMETERS) MINIMUM THICK TIN LEAD IN SOLDER AREA. 15 MICROINCHES (0.38 MICROMETERS) MINIMUM GOLD IN LOCALIZED PLATE AREA. ENTIRE CONTACTS PLATED WITH 50 MICROINCHES (1.27 MICROMETERS) MINIMUM THICK NICKEL.

2. JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68, SUBPART F
3. PART NUMBER: XRJ-U-04-8-8-X-F1

NOTES: UNLESS OTHERWISE SPECIFIED
UNSPECIFIED TOLERANCE: .XX±0.25[0.010]
.X±0.30[0.012]

REFER TO LED OPTIONS TABLE FOR ORDERING CODES

XMULTIPLE		CONNECTING THE INFORMATION AGE
XMULTIPLE AREA 57, No. 60 Julian St. Chapel Hill, N.C. 27514, U.S.A.	XMULTIPLE USA 3540 Old County Road Newport News, VA 23602	P/N: PDU04-802
THIS DRAWING IS A CONTROLLED DOCUMENT.		DRAWN: VIQ
TITLE: RJ45 Connectors, W/LED, BP, BC, UNshilded, Thru-Hole		CHK: C. TSAI
PART NO: XRJM-U-04-8-8-X-F1		DATE: 10/06/01
	DIMENSIONS mm[Inch]	SHEET 1 of 1
		REV J